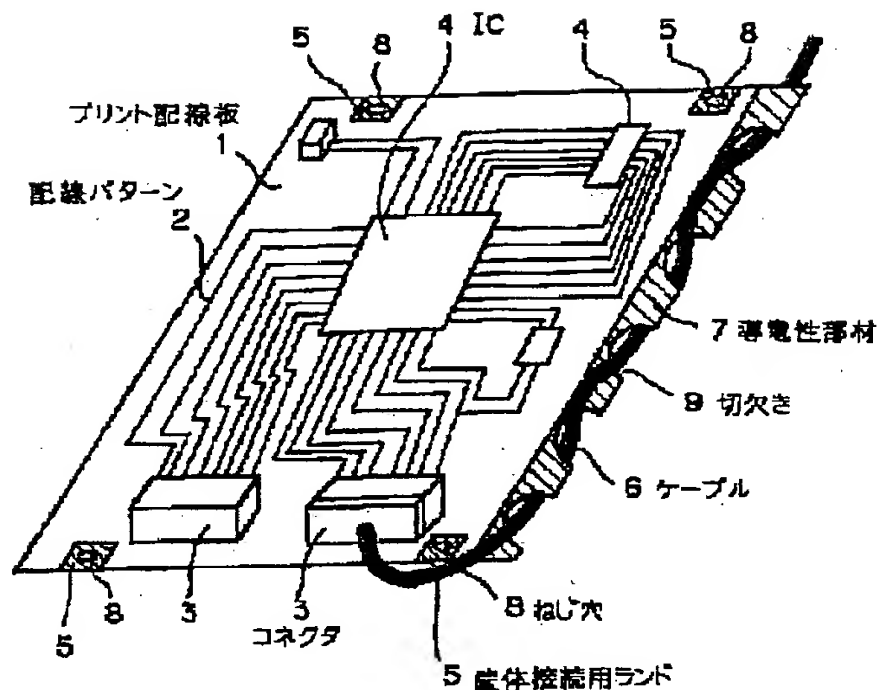


Patent Abstracts of Japan

TITLE : CABLE-WIRING STRUCTURE



SOLUTION: A printed wiring board 1 is formed on its upper face with a wiring pattern 2 and is mounted with an IC 4. The printed wiring board 1 is provided on its side edge with a conductive member 7 made of a conductive material. The conductive member 7 is provided with a plurality of cutouts 9 which are formed serially at regular intervals. A cable 6 is connected to the printed wiring board 1 via a connector 3, being alternately caught through the front and the rear faces of the conductive member 7, using the cutouts 9 formed in the conductive member 7.

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